

Application S/N 10/034,221
Reply to Office Action of June 6, 2003

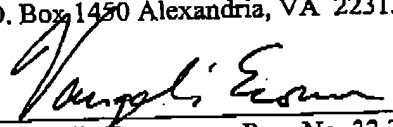
Patent
Attorney Docket No. CU-2755

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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|--------------------|--|---|--------------------------|
| In re Application: | Seung Ho PYI |] | |
| Serial No: | 10/034,221 |] | GRP ART UNIT: 1765 |
| Filed: | December 28, 2001 |] | Ex.: Matthew A. Anderson |
| For: | METHOD FOR FABRICATING A SEMICONDUCTOR EPITAXIAL WAFER HAVING DOPED CARBON AND A SEMICONDUCTOR EPITAXIAL WAFER. |] | |

Certification under 37 C.F.R. §1.8(a)

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being deposited with The United States Postal Service with sufficient postage as first class mail in an envelope addressed to The Commissioner for Patents, P.O. Box 1450 Alexandria, VA 22313-1450 on August 29, 2003.


Vangelis Economou, Reg. No. 32,341

AMENDMENT UNDER 37 CFR 1.111

Commissioner for Patents
P.O. Box 1450
Alexandria VA 22313-1450

AMENDMENT UNDER 37 C.F.R. §1.111

Dear Sir:

In response to the Office Action dated June 6, 2003, setting a 3-month shortened statutory period for a reply ending on Monday, September 8, 2003, Applicant submits the following responsive amendment in the above-identified application. This amendment is considered to place the application in better condition for allowance.

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No fee is believed to be required with this amendment, but, if this is not the case, please charge the requisite fee (or credit any overpayment) to Deposit Account No. 12-0400.

Amendments to the Claims are reflected in the listing of claims, which begins on page 3 of this paper.

Amendment to the Drawings begin on page 7 of this paper and include both an attached replacement sheet and an annotated sheet showing changes.

Remarks/Arguments begin on page 8 of this paper.

An **Appendix** including corrected replacement drawing figures is attached following the last page of this paper.